

Features

- SMD construction, and low profile.
- High Impedance and Excelletn Frequency Characteristic.
- Self Electromagnetic Shielding.
- Low Magnetic Flux Leakage.

Applications

- LED Light,TV game,Monitor,etc.
- EMI common-mode noise.

Product Identification

 $\frac{\mathsf{YLCM}}{(1)} \quad \frac{\square \square \square \square - \square \square \square}{(2)} \quad \frac{\mathsf{T}}{(3)} \quad \frac{\mathsf{T}}{(4)}$

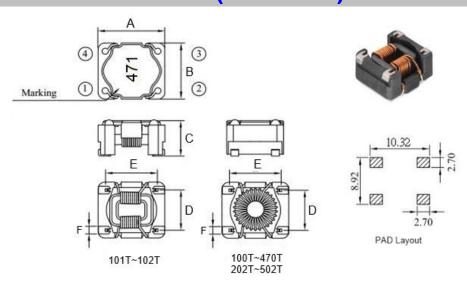
(1): Type

(2): Dimensions

(3): Inductance Value

(4): Taping

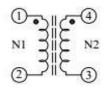
Shapes and Dimensions (Unit: mm)



TYPE	Α	В	C Max	D	E	F
YLCM1006C	10.0±0.5	8.7±0.5	6.5	6.22±0.1	7.62±0.1	1.4 Ref



■ Circuit Diagram



■ YLCM1006C Series

Part Number	Inductance L1=L2(uH) @100KHz/0.1V	DC Resistance (mΩ)Max.	Rated Hi-Pot Current (Vac) (A)Max. 3mA/1S		Impedance (Ω)Min.	Freq. Range (MHz)
YLCM1006C-471T	470±40%	65	1.60	1000	900	2~40

1. Rated Current: Temp.rise 40°C Typ

2. Operating Temperature: -20°C up to +125°C

3.Storage Temperature: -20° C up to $+40^{\circ}$ C, 75% RH max.

Material List

NO.	ITEM	DESCRIPTION		
1	CORE	FERRITE		
2	CASE	DAP-WH9100		
3	WIRE	P180 Grd1		
4	SOLDER	Sn99.3:Cu0.7		
5	ADHESIVE	XNR-3614		
6	INK	WHITE		

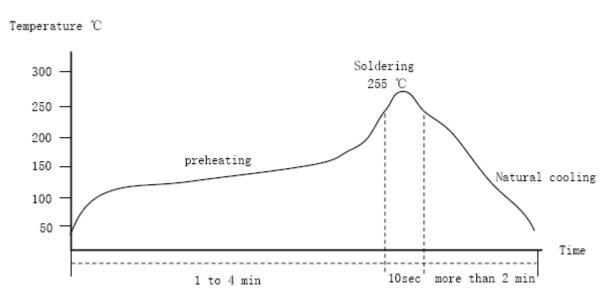


Reliability Testing

Operating Temperature	- 20 to + 125 ℃ (Contain Heating coil)				
Appearance Inspection	No external defects by visual inspection				
Terminal Strength	After soldering , between copper plaet and				
	terminals of coils , push in two directions of X , Y				
X	with standing 10N(1.02kg) for10+/-2 sec.				
	Terminal should not peel off. (Refer to figure at right)				
Heat endurance of reflow	Refer to figure				
soldering					
Insulating resistance	Over 100 $M\Omega$ at 100V D.C . between wire and core .				
Dielectric Strength	Apply at 0.5KV 3mA for 1 minute between wire and core .				
Temperature characteristics	Inductance coefficient ($0\sim2,000$) × 10 / $^{\circ}$ C(- $20\sim$ + 125 $^{\circ}$ C)				
Humidity characteristics	Inductance deviation within ± 10%, after 96 hours in 90~95%				
	relative humidity at 40 ± 2 $^\circ\!$				
A test is made under the abo	ve mentioned condition , and it is kept for 2 hours in the normal				

■ Recommended soldering temp.Graph

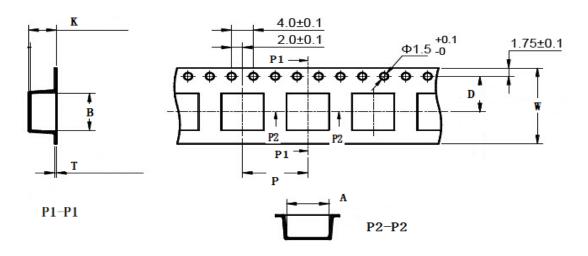
IR Reflow profile



Temperature and humidity. After that, no mechanical and electrical defect should be found.

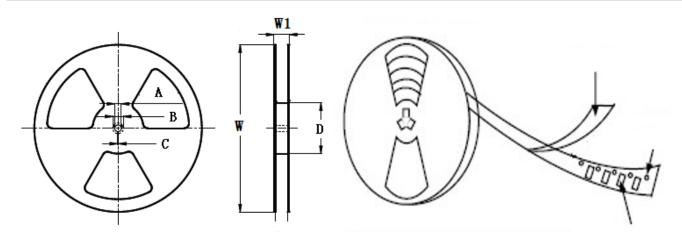


■ Taping Dimensions(Unit:mm)



TYPE	W	Α	В	D	Р	K	Т	MPQ
YLCM1006C	24.0±0.3	10.6±0.3	11. 5±0.1	11.5±0.1	16±0.1	5.0±0.1	0.40±0.05	800

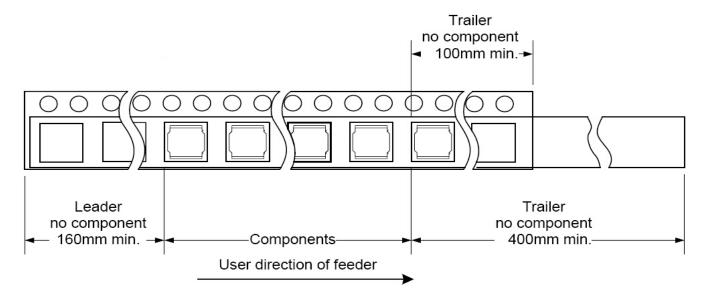
■ Reel Dimensions(Unit:mm)



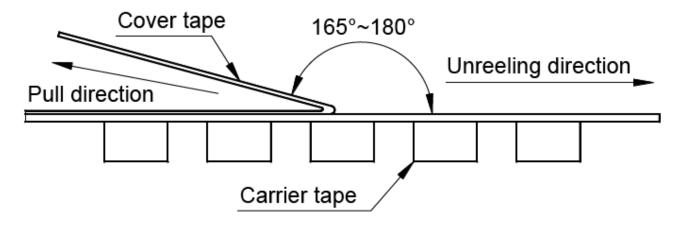
TYPE	W	W1	Α	В	С	D
YLCM1006C	330±2.0	24.4±1.5	30.4MAX	23.9 Min	13.0±0.50	21.0±0.80



■ Direction of rolling



Cover tape peel off condition



Cover tape peel force shall be 0.1N to 1.3N.

Reference peel speed 300±10mm/min.